

High-temperature 60 V, 3 A Schottky barrier rectifier 22 August 2018 Product of

Product data sheet

1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD128 small and flat lead Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Average forward current: $I_{F(AV)} \le 3 A$
- Reverse voltage: $V_R \le 60 V$
- Low forward voltage
- High power capability due to clip-bonding technology
- Small and flat lead SMD plastic package
- AEC-Q101 qualified
- High temperature T_i ≤ 175 °C
- Capable for reflow and wave soldering

3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- · Reverse polarity protection

4. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|--------------------|----------------------------|--|-----|-----|-----|-----|------|
| l _F | forward current | T _{sp} = 160 °C | | - | - | 4.2 | А |
| I _{F(AV)} | average forward current | δ = 0.5; f = 20 kHz; T _{amb} ≤ 80 °C; square wave | [1] | - | - | 3 | A |
| | | δ = 0.5; f = 20 kHz; T _{sp} ≤ 165 °C; square wave | | - | - | 3 | A |
| V _R | reverse voltage | T _j = 25 °C | | - | - | 60 | V |
| V _F | forward voltage | I _F = 3 A; T _j = 25 °C | | - | 460 | 530 | mV |
| I _R | reverse current | $\label{eq:VR} \begin{array}{l} V_{R} \texttt{=} \texttt{60 V}; \ t_{p} \texttt{\leq} \ \texttt{300 } \mu\texttt{s}; \ \texttt{\delta} \texttt{\leq} \ \texttt{0.02}; \\ T_{j} \texttt{=} \texttt{25 °C}; \ \texttt{pulsed} \end{array}$ | | - | 80 | 200 | μA |
| t _{rr} | reverse recovery time | $I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_i = 25 \text{ °C}$ | | - | 12 | - | ns |

[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

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5. Pinning information

| Table 2. | Table 2. Pinning information | | | | | | |
|----------|------------------------------|-------------|--------------------|----------------------|--|--|--|
| Pin | Symbol | Description | Simplified outline | Graphic symbol | | | |
| 1 | К | cathode[1] | | К <mark>-</mark> К-А | | | |
| 2 | A | anode | | sym001 | | | |
| | | | CFP5 (SOD128) | | | | |

[1] The marking bar indicates the cathode.

6. Ordering information

Table 3. Ordering information

| Type number | Package | | | | | |
|-------------|---------|--|---------|--|--|--|
| | Name | Description | Version | | | |
| PMEG6030ETP | CFP5 | plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body | SOD128 | | | |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMEG6030ETP | DA |

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Max | Unit |
|--------------------|--|--|-----|-----|------|------|
| V _R | reverse voltage | T _j = 25 °C | | - | 60 | V |
| l _F | forward current | T _{sp} = 160 °C | | - | 4.2 | А |
| I _{F(AV)} | average forward current | δ = 0.5; f = 20 kHz; T _{amb} \leq 80 °C; square wave | [1] | - | 3 | A |
| | | δ = 0.5; f = 20 kHz; T _{sp} ≤ 165 °C; square wave | | - | 3 | A |
| I _{FSM} | non-repetitive peak forward current | t_p = 8 ms; square wave; $T_{j(init)}$ = 25 °C | | - | 50 | A |
| P _{tot} | total power dissipation | T _{amb} ≤ 25 °C | [2] | - | 750 | mW |
| | | | [3] | - | 1.25 | W |
| | | | [1] | - | 2.5 | W |
| Tj | junction temperature | | | - | 175 | °C |
| T _{amb} | ambient temperature | | | -55 | 175 | °C |
| T _{stg} | storage temperature | | | -65 | 175 | °C |

[1] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit |
|--|--|-------------|---------|-----|-----|-----|------|
| R _{th(j-a)} thermal resistance from junction to ambient | thermal resistance from | in free air | [1] [2] | - | - | 200 | K/W |
| | junction to ambient | | [1] [3] | - | - | 120 | K/W |
| | [| [1] [4] | - | - | 60 | K/W | |
| R _{th(j-sp)} | thermal resistance from junction to solder point | | [5] | - | - | 12 | K/W |

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P_R are a significant part of the total power losses.

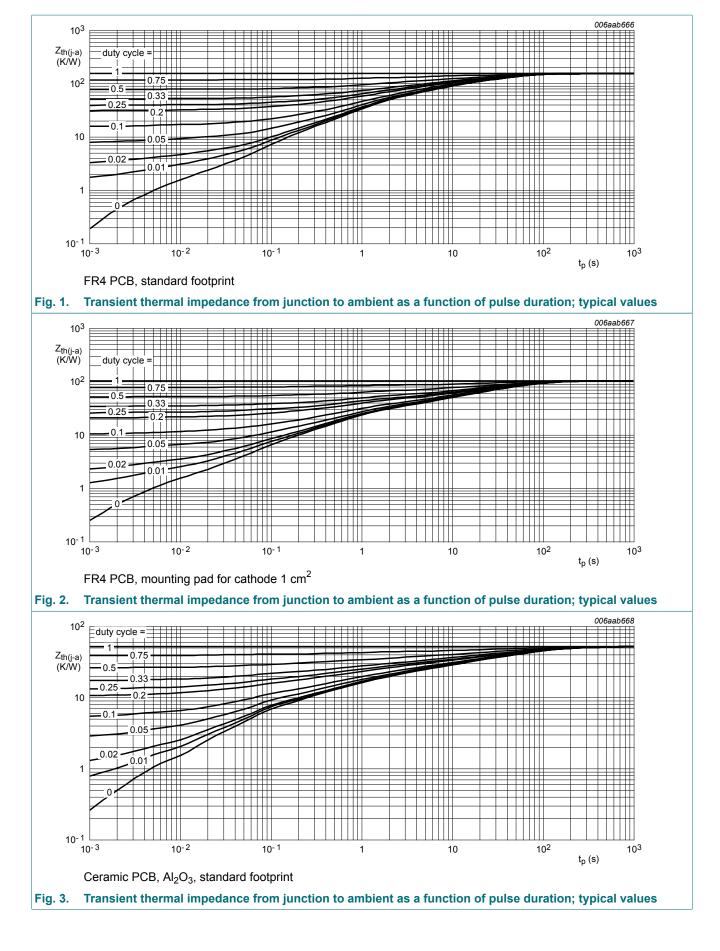
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm².

[4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

[5] Soldering point of cathode tab.

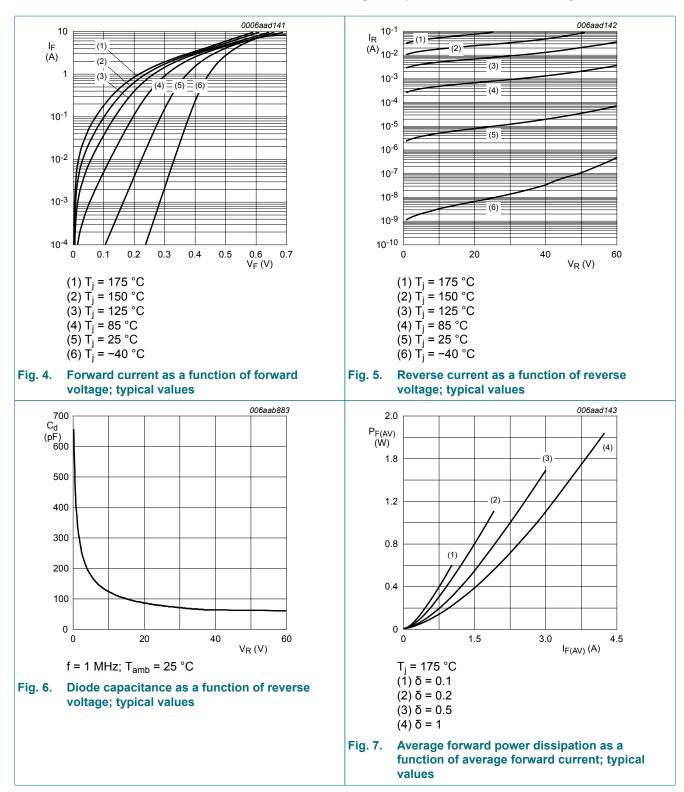
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10. Characteristics

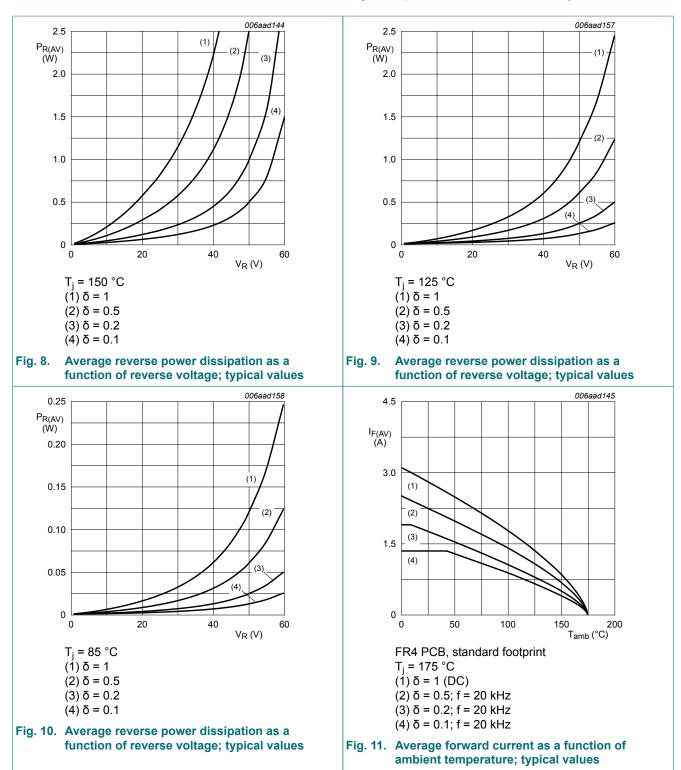
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|-------------------------------|---|-----|-----|-----|------|
| V _F | forward voltage | I _F = 0.1 A; T _j = 25 °C | - | 290 | 330 | mV |
| | | I _F = 0.5 A; T _j = 25 °C | - | 340 | 400 | mV |
| | | I _F = 1 A; T _j = 25 °C | - | 380 | 440 | mV |
| | | I _F = 1.5 A; T _j = 25 °C | - | 400 | 470 | mV |
| | | I _F = 2 A; T _j = 25 °C | - | 430 | 500 | mV |
| | | I _F = 3 A; T _j = 25 °C | - | 460 | 530 | mV |
| | | I _F = 3 A; T _j = -40 °C | - | 510 | 590 | mV |
| | | I _F = 3 A; T _j = 125 °C | - | 405 | 480 | mV |
| | | I _F = 3 A; T _j = 150 °C | - | 390 | 460 | mV |
| | | I _F = 3 A; T _j = 175 °C | - | 370 | 450 | mV |
| I _R | reverse current | $V_R = 5 V; t_p \le 300 \ \mu s; \delta \le 0.02;$ $T_j = 25 \ ^{\circ}C; \ pulsed$ | - | 4 | - | μA |
| | | V_R = 10 V; $t_p \le 300 \ \mu s; \delta \le 0.02;$ T _j = 25 °C; pulsed | - | 5 | - | μA |
| | | V_R = 60 V; $t_p \le 300 \ \mu s; \delta \le 0.02;$ T_j = 25 °C; pulsed | - | 80 | 200 | μA |
| | | V_R = 60 V; t _p ≤ 300 µs; δ ≤ 0.02; T _j = -40 °C; pulsed | - | 0.5 | 10 | μA |
| | | $ \begin{array}{l} V_{R} \texttt{=} \texttt{60 V}; t_{p} \texttt{\leq} \ \texttt{300 } \mu \texttt{s}; \bar{\texttt{0}} \texttt{\leq} \ \texttt{0.02}; \\ T_{j} \texttt{=} \ \texttt{125 }^\circ \texttt{C}; pulsed \end{array} $ | - | 45 | 150 | mA |
| C _d | diode capacitance | V _R = 1 V; f = 1 MHz; T _j = 25 °C | - | 360 | - | pF |
| | | V _R = 10 V; f = 1 MHz; T _j = 25 °C | - | 120 | - | pF |
| t _{rr} | reverse recovery time | $ I_F = 0.5 \text{ A}; \ I_R = 0.5 \text{ A}; \ I_{R(meas)} = 0.1 \text{ A}; \\ T_j = 25 \ ^\circ\text{C} $ | - | 12 | - | ns |
| V _{FRM} | peak forward recovery voltage | I _F = 1 A; dI _F /dt = 40 A/μs; T _j = 25 °C | - | 425 | - | mV |

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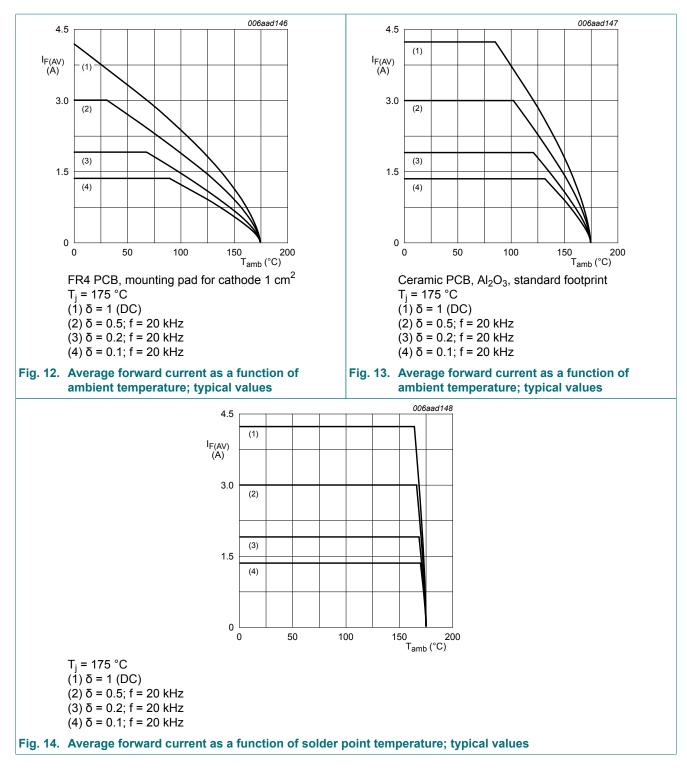


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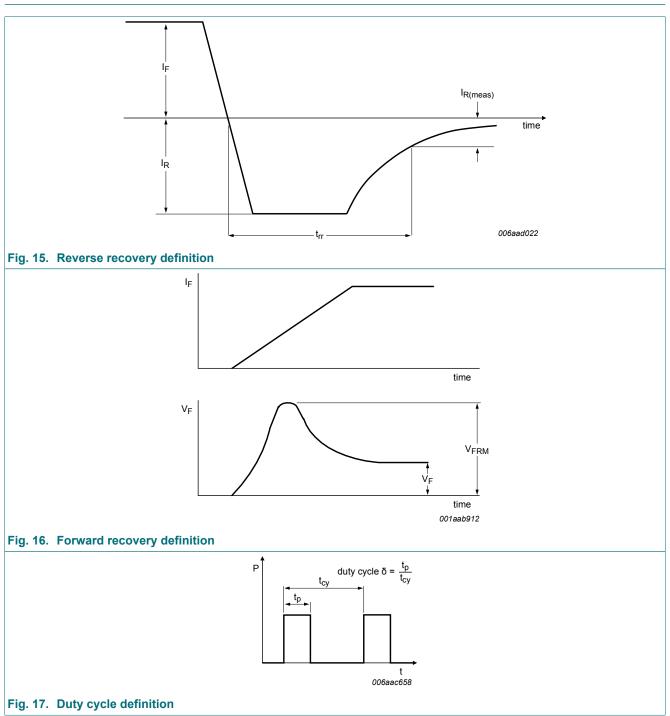






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11. Test information

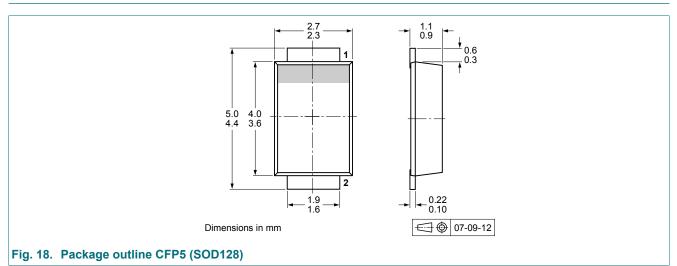


The current ratings for the typical waveforms are calculated according to the equations: $I_{F(AV)} = I_M \times \delta$ with I_M defined as peak current, $I_{RMS} = I_{F(AV)}$ at DC, and $I_{RMS} = I_M \times \sqrt{\delta}$ with I_{RMS} defined as RMS current.

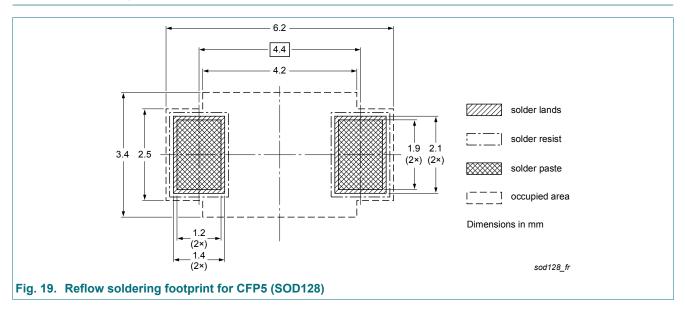
Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

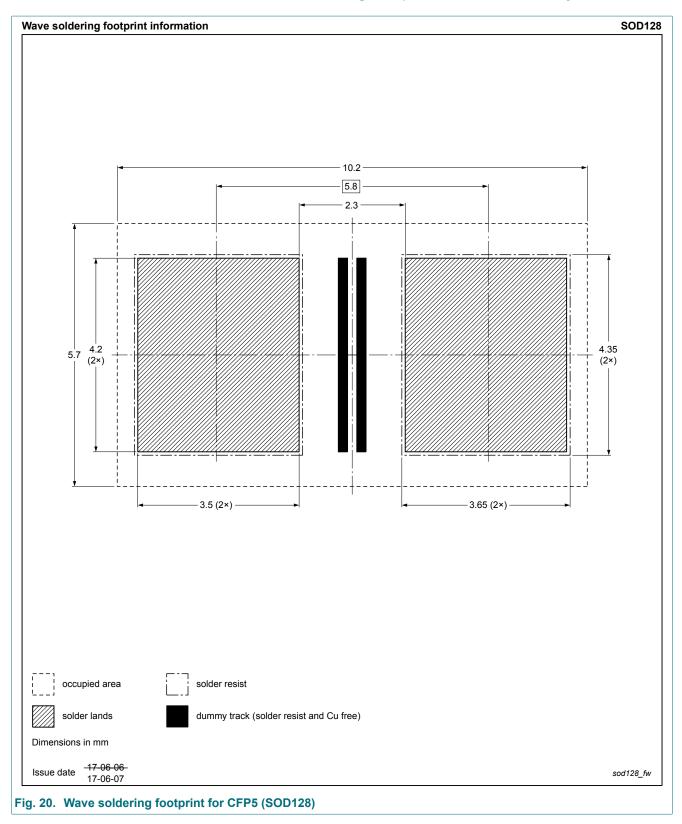
12. Package outline



13. Soldering



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14. Revision history

| Table 8. Revision history | | | | | | | | |
|---------------------------|---|--------------------|---------------|-----------------|--|--|--|--|
| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes | | | | |
| PMEG6030ETP v.2 | 20180822 | Product data sheet | - | PMEG6030ETP v.1 | | | | |
| Modifications | Features and benefits: Capable for reflow and wave soldering added. Soldering: Wave soldering footprint added. | | | | | | | |
| PMEG6030ETP v.1 | 20121015 | Product data sheet | - | - | | | | |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|-----------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <u>https://www.nexperia.com</u>.

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